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AKM

CQ-206B
High-Speed Small-Sized Current Sensor

Overview

CQ-206B is an open-type current sensor using a Hall sensor which outputs the analog voltage proportional to the AC/DC current. Quantum well ultra-thin film InAs (Indium Arsenide) is used as the Hall sensor, which enables the high-accuracy and high-speed current sensing. Simple AI-Shell package with the Hall sensor, magnetic core, and primary conductor realizes the space-saving and high reliability.

Features

- Unidirectional type
- Electrical isolation between the primary conductor and the sensor signal
- 5V single supply operation
- Ratiometric output
- Low variation and low temperature drift of sensitivity and offset voltage
- Low noise output: 2.1mVrms (max.)
- Fast response time: 1µs (typ.)
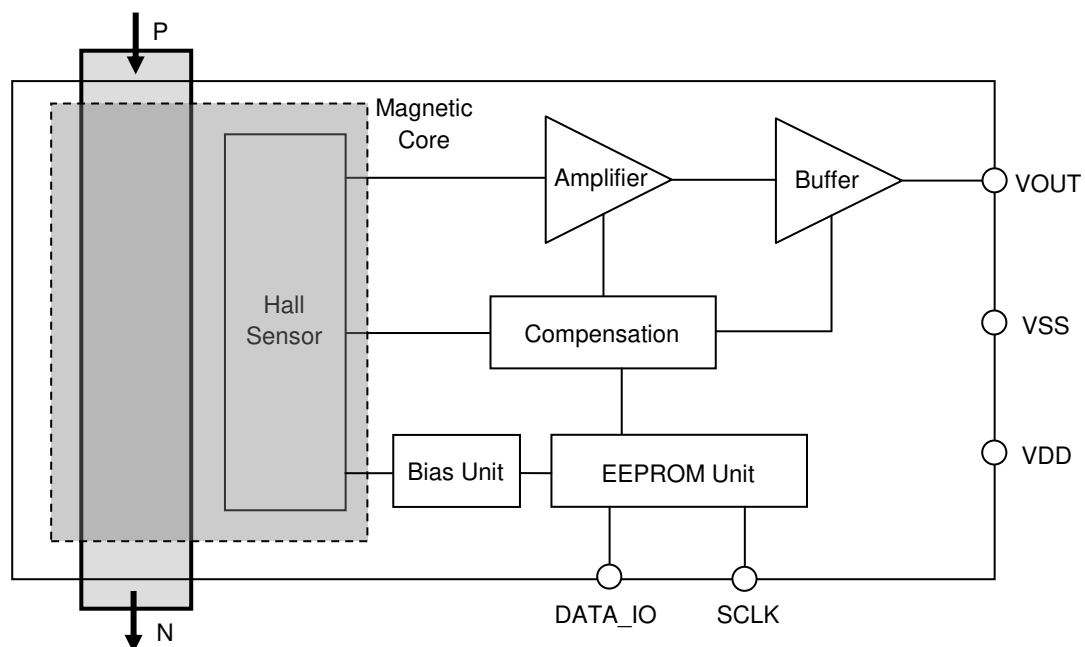- Small-sized package, halogen free

Functional Block Diagram

Figure 1. Functional block diagram of CQ-206B

Circuit Blocks

Table 1. Explanation of circuit blocks

| Circuit Block	Function
Hall Sensor	Hall element which detects magnetic flux density generated from the measured current.
Amplifier	Amplifier of Hall element's output.
Buffer	Output buffer with gain. This block outputs the voltage (V_{OUT}) proportional to the current applied to the primary conductor.
Compensation	Compensation circuit which adjusts the temperature drifts of sensitivity and offset voltage.
Bias Unit	Drive circuit for Hall element.
EEPROM Unit	Non-volatile memory for setting adjustment parameters. The parameters are adjusted before the shipment.
Magnetic Core	Magnetic core which gathers the magnetic flux density to the Hall element.

Typical Output Characteristics
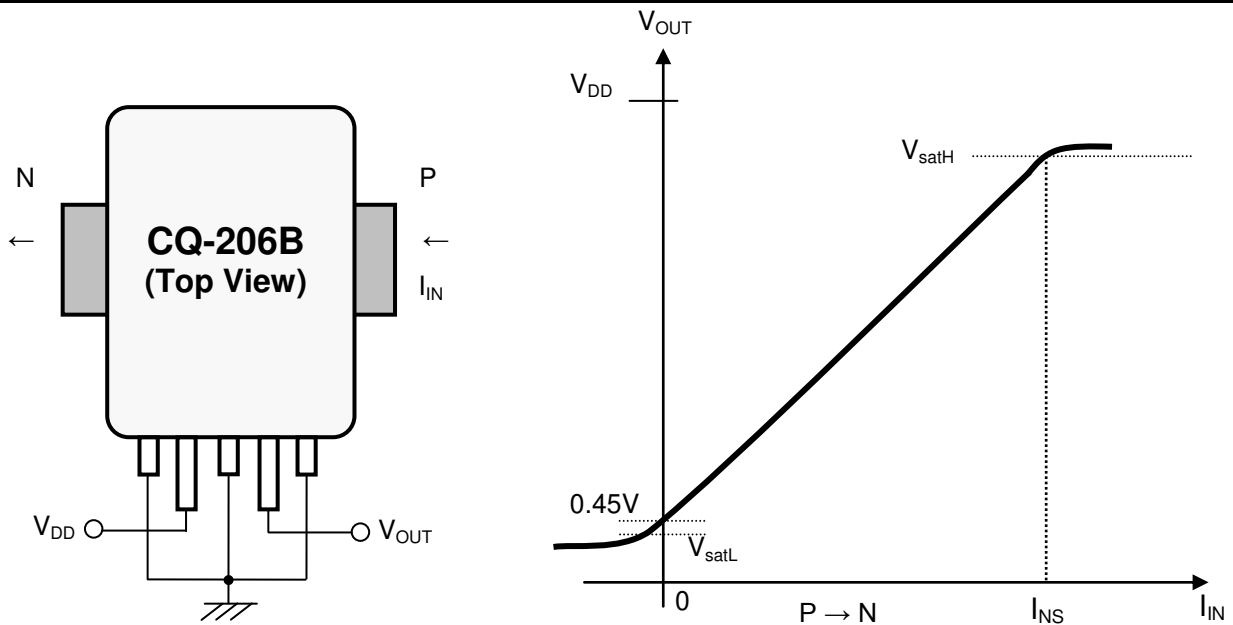
Figure 2. Typical output characteristics of CQ-206B

Pin/Function

Table 2. Pin-out description

No.	Name	I/O	Description
1	DATA_IO	-	Test pin (connect to ground)
2	VDD	-	Power supply pin (5V)
3	VSS	-	Ground pin (0V)
4	VOUT	O	Analog output pin
5	SCLK	-	Test pin (connect to ground)
6	P	I	Primary current pin (+)
7	N	I	Primary current pin (−)
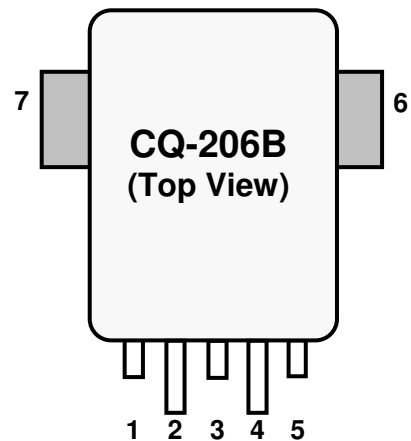
Figure 3. Pin-out diagram

Absolute Maximum Ratings

Table 3. Absolute maximum ratings

Parameter	Symbol	Min.	Max.	Units	Notes
Supply Voltage	V_{DD}	−0.3	6.5	V	VDD
Analog Output Current	I_{OUT}	−1	1	mA	VOUT
Storage Temperature	T_{stg}	−40	125	°C	

WARNING: Operation at or beyond these limits may result in permanent damage to the device. Normal operation is not guaranteed at these extremes.

Primary Current Derating Curve

Conditions: Mounted on the test board complying with the EIA/JEDEC Standards (EIA/JESD51.)
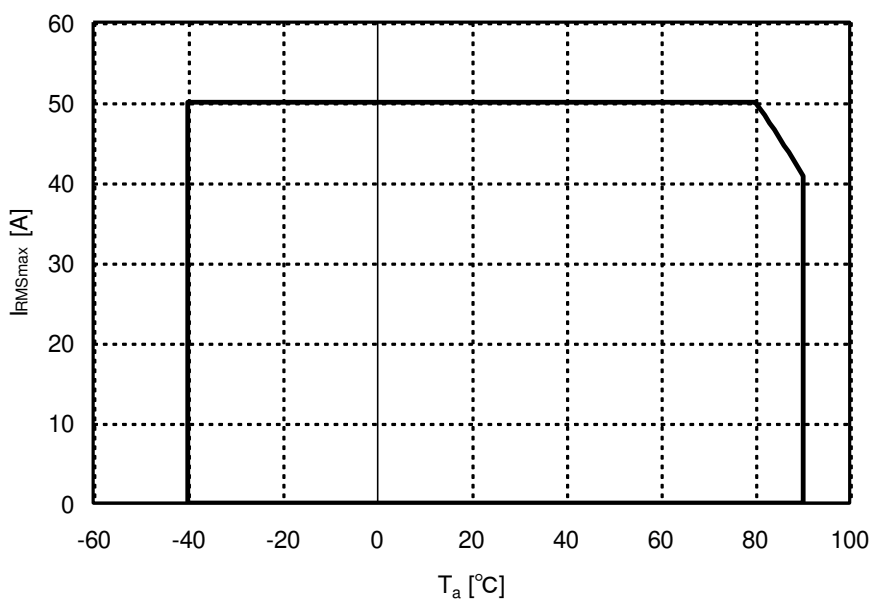
NOTE) Cooling or thermal radiation will improve the derating curve above.

Figure 4. Primary current derating curve of CQ-206B

Recommended Operating Conditions

Table 4. Recommended operating conditions

Parameter	Symbol	Min.	Typ.	Max.	Units	Notes
Supply Voltage	V_{DD}	4.5	5.0	5.5	V	
Output Current	I_{OUT}	−0.5		0.5	mA	VOUT
Output Load Capacitance	C_L			100	pF	VOUT
Operating Ambient Temperature	T_a	−40		90	°C	

NOTE: Electrical characteristics are not guaranteed when operated at or beyond these conditions.

Electrical Characteristics

Table 5. Electrical characteristics

Conditions (unless otherwise specified): T_a=25°C, V_{DD}=5V

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Maximum Primary Current (RMS)	I_{RMSmax}		0		50	A
Current Consumption	I_{DD}	No Loads			9	mA
Sensitivity*	V_h		88.2	90	91.8	mV/A
Offset Voltage*	V_{of}	I_{IN}=0A	0.34	0.45	0.56	V
Linear Sensing Range	I_{NS}		0		45	A
Linearity Error*	ρ		−1		1	%F.S.
Rise Response Time	t_r	I_{IN} 90% → V_{OUT} 90% C_L=100pF		1		µs
Fall Response Time	t_f	I_{IN} 10% → V_{OUT} 10% C_L=100pF		1		µs
Bandwidth	f_T	−3dB, C_L=100pF		400		kHz
Output Noise**	V_{Nrms}				2.1	mVrms
Maximum Temperature Drift of Sensitivity	V_{h-dmax}	Variation ratio to V_h(T_a=35°C) T_a=−40~90°C		±2		%
Maximum Temperature Drift of Offset voltage	$V_{of-dmax}$	Variation from V_{of}(T_a=35°C) T_a=−40~90°C, I_{IN}=0A		±27.5		mV
Ratiometricity Error of Sensitivity**	V_{h-R}	V_{DD}=4.5V~5.5V	−1		1	%
Ratiometricity Error of Offset Voltage**	V_{of-R}	V_{DD}=4.5V~5.5V I_{IN}=0A	−0.6		0.6	%
Primary Conductor Resistance	R_1			100		µΩ
Isolation Voltage**	V_{INS}	AC 50/60Hz, 60s	2.5			kV
Isolation Resistance**	R_{INS}	DC 1kV	500			MΩ

* These parameters can drift by the values described in 'Reliability Tests' section over the lifetime of the product.
** These characteristics are guaranteed by design.

Characteristics Definitions

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(1) Sensitivity V_h [mV/mT], offset voltage V_{of} [V]

Sensitivity is defined as the slope of the approximate straight line calculated by the least square method, using the data of VOUT voltage (V_{OUT}) when the primary current (I_{IN}) is swept within the range of linear sensing range (I_{NS}). Offset voltage is defined as the intercept of the approximate straight line above.

(2) Linearity error ρ [%F.S.]

Linearity error is defined as the ratio of the maximum error voltage (V_d) to the full scale (F.S.), where V_d is the maximum difference between the VOUT voltage (V_{OUT}) and the approximate straight line calculated in the sensitivity and offset voltage definition. Definition formula is shown in below:

$$\rho = V_d \,/\, F.S. \times 100$$

NOTE) Full scale (F.S.) is defined by the multiplication of the linear sensing range and sensitivity (See Figure 5).
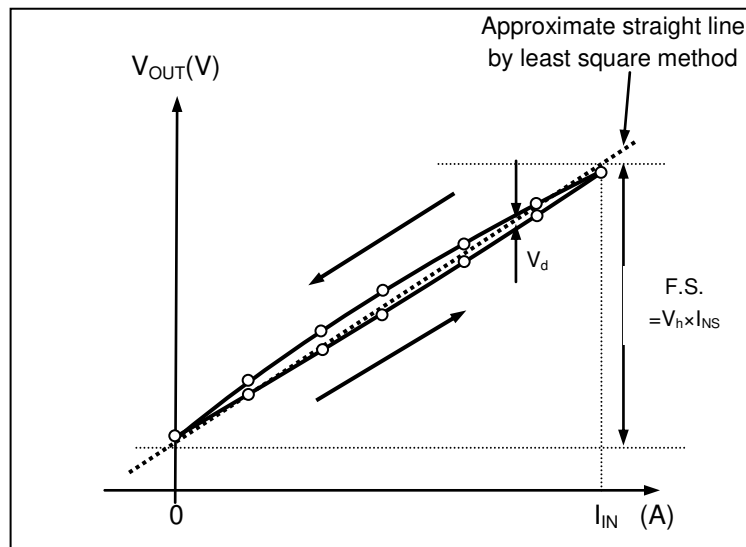
Figure 5. Output characteristics of CQ-206B

(3) Ratiometric error of sensitivity $V_{h\text{-}R}$ [%] and ratiometric error of offset voltage $V_{of\text{-}R}$ [%]

Output of CQ-206B is ratiometric, which means the values of sensitivity (V_h) and offset voltage (V_{of}) are proportional to the supply voltage (V_{DD}). Ratiometric error is defined as the difference between the V_h (or V_{of}) and ideal V_h (or V_{of}) when the V_{DD} is changed from 5.0V to V_{DD1} (4.5V<V_{DD1}<5.5V). Definition formula is shown in below:

$$V_{h\text{-}R} = 100 \times \{(V_h(V_{DD} = V_{DD1}) \,/\, V_h(V_{DD} = 5V)) - (V_{DD1} \,/\, 5)\} \,/\, (V_{DD1} \,/\, 5)$$
$$V_{of\text{-}R} = 100 \times (\, V_{of}(V_{DD} = V_{DD1}) - V_{of}(V_{DD} = 5V) \times (V_{DD1} \,/\, 5)\,) \,/\, F.S.$$

(4) Temperature drift of sensitivity $V_{h\text{-}d}$ [%]

Temperature drift of sensitivity is defined as the drift ratio of the sensitivity (V_h) at $T_a = T_{a1}$ (−40°C<T_{a1}<90°C) to the V_h at $T_a = 35$°C, and calculated from the formula below:

$$V_{h\text{-}d} = 100 \times (V_h(T_{a1}) \,/\, V_h(35°C) - 1)$$

Maximum temperature drift of sensitivity ($V_{h\text{-}dmax}$) is defined as the maximum value of |$V_{h\text{-}d}$| through −40°C<T_{a1}<90°C. *(continued)*

Reference data of the temperature drift of sensitivity of CQ-206B is shown in Figure 6.

(5) Temperature drift of offset voltage V_of-d [mV]

Temperature drift of offset voltage is defined as the drift value between the offset voltage (V_{of}) at $T_a=T_{a1}$ ($-40°C<T_{a1}<90°C$) and the V_{of} at $T_a=35°C$, and calculated from the formula below:

$$V_{of-d} = V_{of}(T_a = T_{a1}) - V_{of}(T_a = 35°C)$$

Maximum temperature drift of offset voltage ($V_{of-dmax}$) is defined as the maximum value of $|V_{h-d}|$ through $-40°C<T_{a1}<90°C$.

Reference data of the temperature drift of offset voltage of CQ-206B is shown in Figure 7.
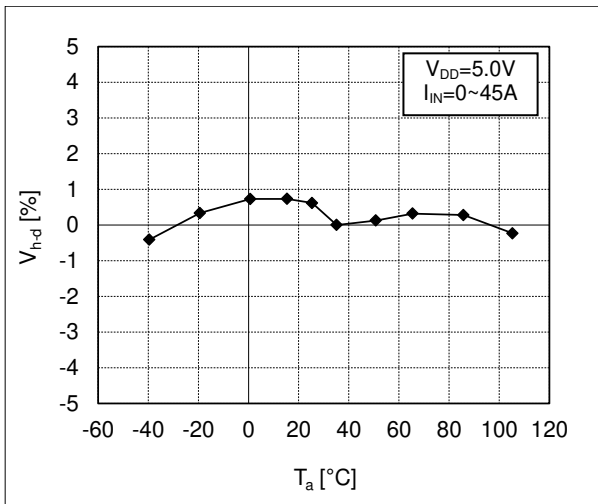
Figure 6. Temperature drift of sensitivity of CQ-206B (for reference, n=1)
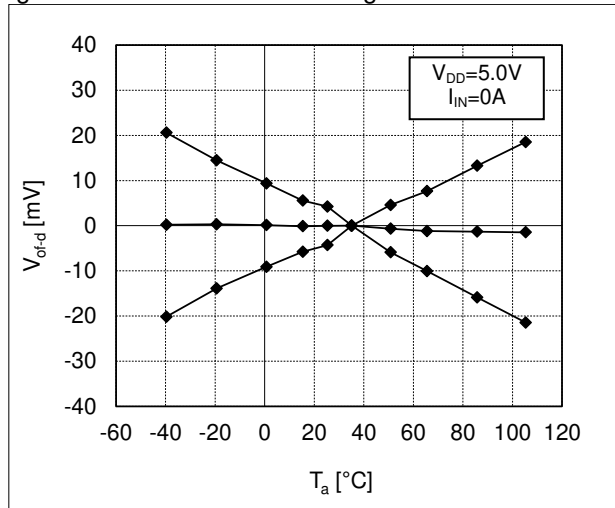
Figure 7. Temperature drift of offset voltage of CQ-206B (for reference, n=3)

(6) Rise response time t_r [μs] and fall response time t_f [μs]

Rise response time (or fall response time) is defined as the time delay from the 90% (or 10%) of input primary current (I_{IN}) to the 90% (or 10%) of the VOUT voltage (V_{OUT}) under the pulse input of primary current (see Figure 8.)
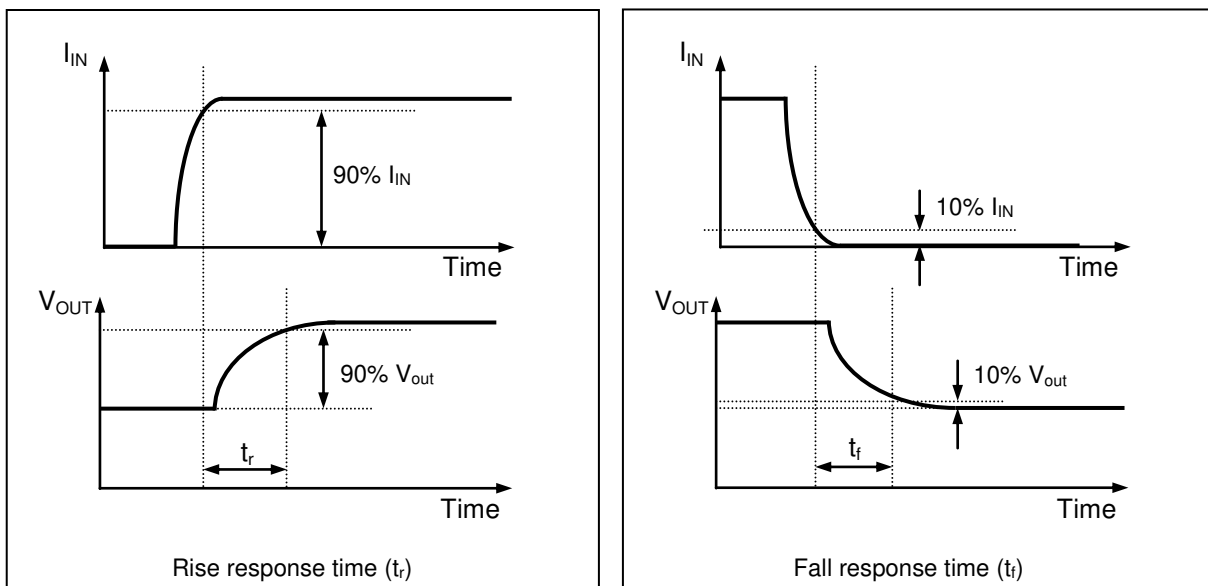
Figure 8. Definition of response time

Package Dimensions
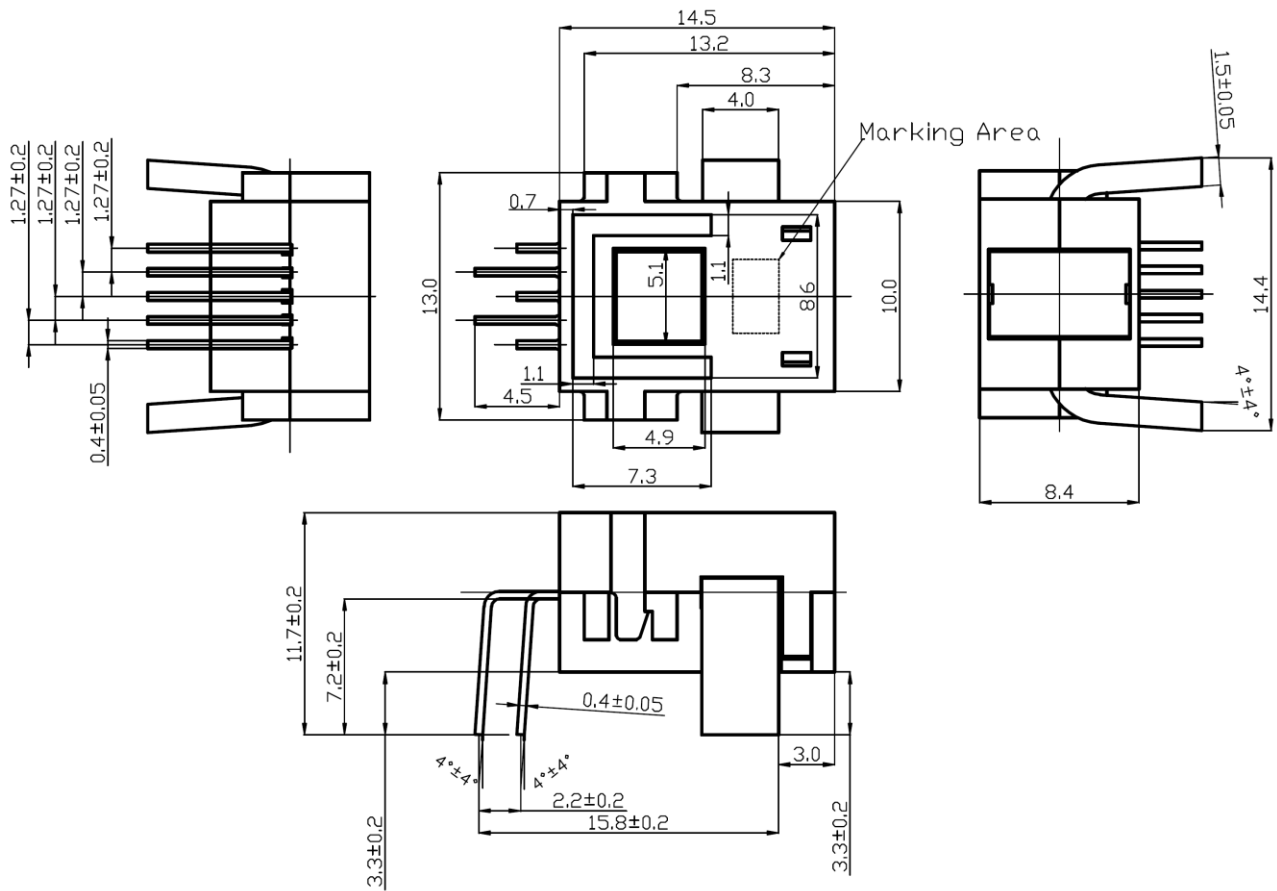
Unit:mm

Note1) The tolerances of dimensions without any mention are ±0.1mm.

Terminals: Cu
Plating for Terminals: Sn (100%)
RoHS compliant, halogen free

Figure 9. Package outline
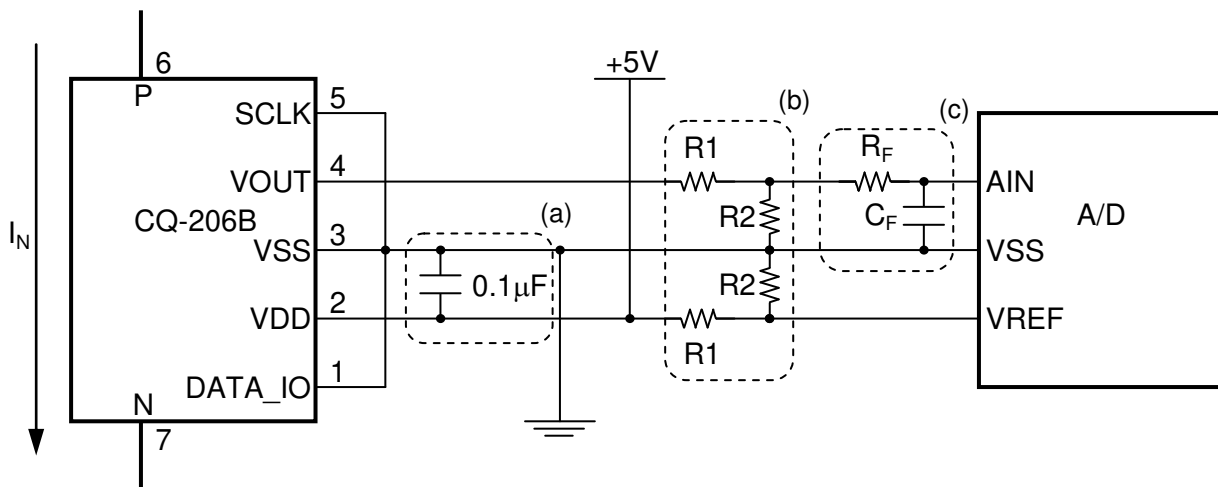
Recommended Land Pattern (Reference Only)
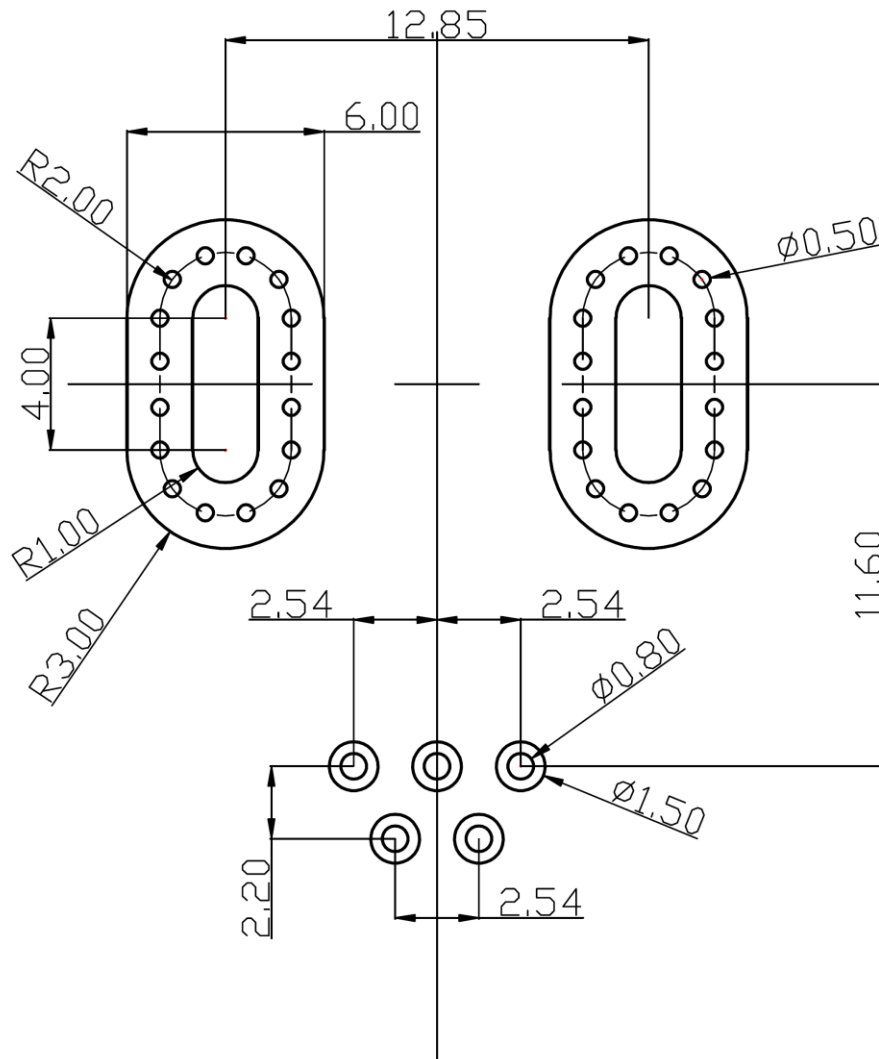
Unit:mm

Figure 10. Recommended land pattern of CQ-206B

Note) If 2 or more trace layers are used as the current path, please make enough number of through-holes to flow current between the trace layers.

Application Circuits

(a) 0.1μF bypass capacitor should be placed near by the CQ-206B
(b) Ratiometric output of CQ-206B enables an A/D system to improve the A/D conversion error caused by the fluctuation of supply voltage. This is achieved by making the supply voltage of CQ-206B and the reference voltage of A/D converter common.
   Voltage dividers (R1 and R2) are required if the reference voltage of A/D converter is less than +5V.
   For example, if the reference voltage of A/D converter is +3.3V which is its supply voltage level, R1=20kΩ , R2=39kΩ are recommended. If the reference voltage of A/D converter is different from its supply voltage level, one more voltage divider is required.
(c) Add a low-pass filter if it is necessary.

Figure 11. Recommended circuits when using A/D converter

Markings

Production information is printed on the package surface by laser marking. Markings consist of 12 characters (6 characters × 2 lines).

Q206B∗ ◄────────── Product Code(CQ-206B) + Option

∗∗∗∗∗∗ ◄────────── Option (3 characters)

────────── Production Date (Y/M/D)
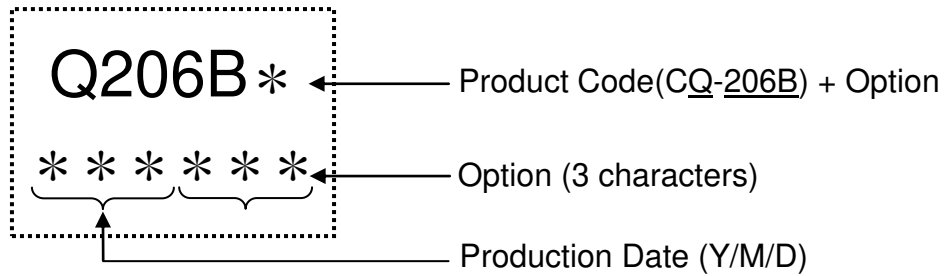
Figure 12. Markings of CQ-206B

Table 6. Production date code table

Last Number of Year		Month		Day	
Character	Number	Character	Month	Character	Day
0	0	C	Jan.	1	1
1	1	D	Feb.	2	2
2	2	E	Mar.	3	3
3	3	F	Apr.	4	4
4	4	G	May.	5	5
5	5	H	Jun.	6	6
6	6	J	Jul.	7	7
7	7	K	Aug.	8	8
8	8	L	Sep.	9	9
9	9	M	Oct.	0	10
		N	Nov.	A	11
		P	Dec.	B	12
				C	13
				D	14
				E	15
				F	16
				G	17
				H	18
				J	19
				K	20
				L	21
				N	22
				P	23
				R	24
				S	25
				T	26
				U	27
				V	28
				W	29
				X	30
				Y	31

Reliability Tests

Table 7. Test parameters and conditions of reliability test

No.	Test Parameter	Test Conditions	n	Test Time
1	High Humidity Storage Test	【JEITA EIAJ ED-4701 102】 T_a=85°C, 85%RH, continuous operation	22	1000h
2	High Temperature Bias Test	【JEITA EIAJ ED-4701 101】 T_a=125°C, continuous operation	22	1000h
3	High Temperature Storage Test	【JEITA EIAJ ED-4701 201】 T_a=150°C	22	1000h
4	Low Temperature Storage Test	【JEITA EIAJ ED-4701 202】 T_a= −55°C	22	1000h
5	Heat Cycle Test	【JEITA EIAJ ED-4701 105】 −65°C ↔ 150°C 30min. ↔ 30min. Tested in vapor phase	22	500 cycles
6	Vibration Test	【JEITA EIAJ ED-4701 403】 Vibration frequency: 10~55Hz (1min.) Vibration amplitude: 1.5mm (x, y, z directions)	5	2h for each direction

Tested samples are pretreated as below before each reliability test:
      Desiccation: 125°C /24h → Moisture Absorption: 85°C/85%RH/168h → Flow: 1 time (260°C, 10s)

Criteria:
      Products whose drifts before and after the reliability tests do not exceed the values below are considered to be in spec.
          Sensitivity V_h (T_a=25°C)   : Within ±1.5%
          Offset Voltage V_{of} (T_a=25°C)   : Within ±100mV
          Linearity ρ (T_a=25°C)   : Within ±1%

Precautions

<Storage Environment>

   Products should be stored at an appropriate temperature and humidity (5 to 35°C, 40 to 85%RH).
   Keep products away from chlorine and corrosive gas.

<Long-term Storage>

   Long-term storage may result in poor lead solderability and degraded electrical performance even under proper conditions. For those parts, which stored long –term shall be check solderability before it is used.
   For storage longer than 2 years, it is recommended to store in nitrogen atmosphere. Oxygen of atmosphere oxidizes leads of products and lead solderability get worse.

<Other precautions>

   1) This product should not be used under the environment with corrosive gas including chlorine or sulfur.
   2) This product is lead (Pb) free. All leads are plated with 100% tin. Do not store this product alone in high temperature and high humidity environment. Moreover, this product should be mounted on substrate within six months after delivery.
   3) This product is damaged when it is used on the following conditions:
        ・Supply voltage is applied in the opposite way.
        ・Overvoltage which is larger than the value indicated in the specification.
   4) This product will be damaged if it is used for a long time with the current (effective current) which exceeds the current rating. Careful attention must be paid so that maximum effective current is smaller than current rating.
   5) Since magnetic cores are fragile parts, do not use the fallen products.
   6) The characteristic can change by the influences of nearby current and magnetic field. Please make sure of the mounting position.

As this product contains gallium arsenide, observe the following procedures for safety.
   1) Do not alter the form of this product into a gas, powder, liquid, through burning, crushing, or chemical processing.
   2) Observe laws and company regulations when discarding this product.

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